

TYPES 2N3583, 2N3584, 2N3585, 2N4240 N-P-N SILICON POWER TRANSISTORS

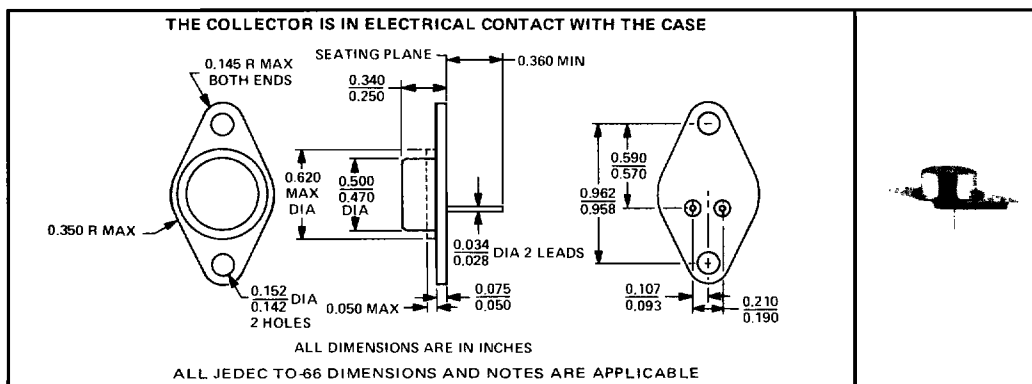
HIGH-VOLTAGE POWER TRANSISTORS DESIGNED FOR INDUSTRIAL AND MILITARY APPLICATIONS

- Min $V_{(BR)CEO}$ of 300 V (2N3585, 2N4240)
- Typ $V_{CE(sat)}$ of 0.25 V at $I_B = 125$ mA, $I_C = 1$ A
- Typ t_{on} of 0.2 μ s, at 750 mA, 200 V (2N4240)
- Min f_T of 15 MHz at 10 V, 200 mA (2N4240)
- 35 W at 25°C Case Temperature

TYPES 2N3583, 2N3584, 2N3585, 2N4240
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5

*mechanical data



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	2N3583	2N3584	2N3585	2N4240
Collector-Base Voltage	250 V*	375 V*	500 V*	500 V*
Collector-Emitter Voltage (See Note 1)	175 V*	250 V*	300 V*	300 V*
Emitter-Base Voltage	6 V*			
Continuous Collector Current	1 A*	2 A*	2 A*	2 A*
Peak Collector Current (See Note 2)	5 A*	5 A*	5 A*	5 A*
Continuous Base Current	1 A*			
Safe Operating Area at 100°C Case Temperature	See Figure 5			
Continuous Device Dissipation at (or below) 25°C Case Temperature (See Note 3)	35 W*			
Continuous Device Dissipation at 100°C Case Temperature (See Note 3)	20 W*			
Continuous Device Dissipation at (or below) 25°C Free-Air Temperature (See Note 4)	2 W			
Operating Collector Junction Temperature Range	-65°C to 200°C*			
Storage Temperature Range	-65°C to 200°C*			
Terminal Temperature 1/32 Inch from Case for 10 Seconds	235°C*			

- NOTES: 1. This value applies when the base-emitter diode is open-circuited.
2. This value applies for $t_w \leq 0.3$ ms, duty cycle $\leq 10\%$.
3. Derate linearly to 200°C case temperature at the rate of 0.2 W/°C.
4. Derate linearly to 200°C free-air temperature at the rate of 11.4 mW/°C.

*JEDEC registered data. This data sheet contains all applicable registered data in effect at the time of publication.

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N-P-N SILICON POWER TRANSISTORS

*electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	2N3583		2N3584		2N3585		2N4240		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$V_{(BR)CEO}$ Collector-Emitter Breakdown Voltage	$I_C = 200 \text{ mA}$, $I_B = 0$, See Note 5	175		250		300		300		V
I_{CEO} Collector Cutoff Current	$V_{CE} = 150 \text{ V}$, $I_B = 0$	10								mA
I_{CEV} Collector Cutoff Current	$V_{CE} = 225 \text{ V}$, $V_{BE} = -1.5 \text{ V}$	1								mA
	$V_{CE} = 340 \text{ V}$, $V_{BE} = -1.5 \text{ V}$			1						
	$V_{CE} = 450 \text{ V}$, $V_{BE} = -1.5 \text{ V}$					1				
	$V_{CE} = 225 \text{ V}$, $V_{BE} = -1.5 \text{ V}$, $T_C = 150^\circ\text{C}$	3								
	$V_{CE} = 300 \text{ V}$, $V_{BE} = -1.5 \text{ V}$, $T_C = 150^\circ\text{C}$			3		3		3		
I_{EBO} Emitter Cutoff Current	$V_{EB} = 6 \text{ V}$, $I_C = 0$	5		0.5		0.5		0.5		mA
h_{FE} Static Forward Current Transfer Ratio	$V_{CE} = 10 \text{ V}$, $I_C = 0.5 \text{ A}$	40	200							
	$V_{CE} = 10 \text{ V}$, $I_C = 1 \text{ A}$	10								
	$V_{CE} = 2 \text{ V}$, $I_C = 1 \text{ A}$			8	80	8	80			
	$V_{CE} = 2 \text{ V}$, $I_C = 0.75 \text{ A}$							10	100	
V_{BE} Base-Emitter Voltage	$I_B = 75 \text{ mA}$, $I_C = 0.75 \text{ A}$								1.8	V
	$I_B = 0.1 \text{ A}$, $I_C = 1 \text{ A}$				1.4		1.4			
	$V_{CE} = 10 \text{ V}$, $I_C = 1 \text{ A}$		1.4							
$V_{CE(sat)}$ Collector-Emitter Saturation Voltage	$I_B = 75 \text{ mA}$, $I_C = 0.75 \text{ A}$								1	V
	$I_B = 125 \text{ mA}$, $I_C = 1 \text{ A}$		5		0.75		0.75			
h_{fe} Small-Signal Common-Emitter Forward Current Transfer Ratio	$V_{CE} = 30 \text{ V}$, $I_C = 0.1 \text{ A}$, $f = 1 \text{ kHz}$	25	350							
$ h_{fe} $ Small-Signal Common-Emitter Forward Current Transfer Ratio	$V_{CE} = 10 \text{ V}$, $I_C = 0.2 \text{ A}$, $f = 5 \text{ MHz}$	2		2		2		3		

NOTES: 5. These parameters must be measured using pulse techniques. $t_w = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 0.125 inch from the device body.

*JEDEC registered data

thermal characteristics

PARAMETER	MAX	UNIT
$R_{\theta JC}$ Junction-to-Case Thermal Resistance	5	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction-to-Free-Air Thermal Resistance	87.5	

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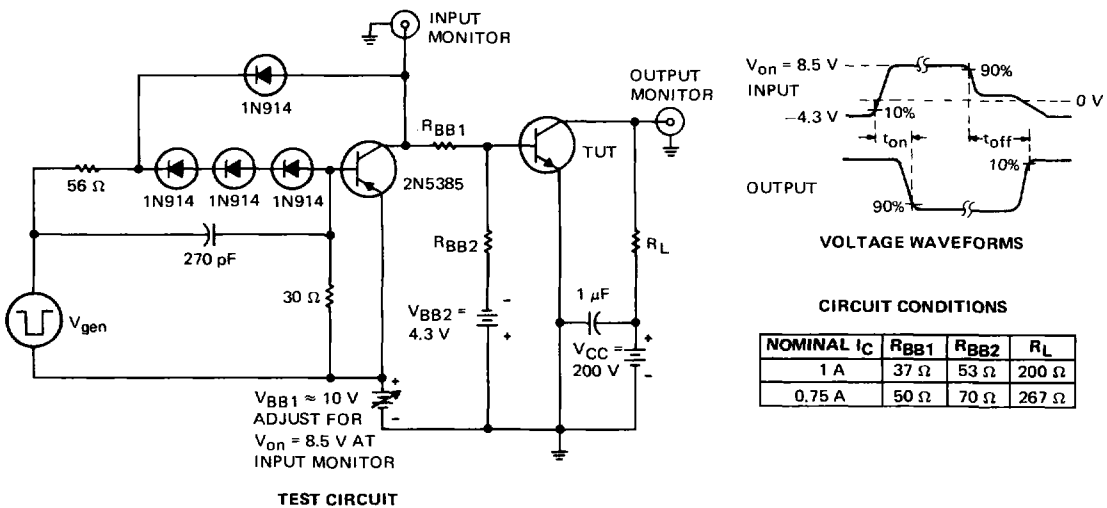
*switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS‡	2N3584 2N3585		2N4240		UNIT
		TYP	MAX	TYP	MAX	
t_r Rise Time	$I_C = 1\text{ A}$, $I_B(1) = 100\text{ mA}$, $I_B(2) = -100\text{ mA}$, $V_{BE(off)} = -4.3\text{ V}$, $R_L = 200\ \Omega$, See Figure 1	1	3			μs
t_s Storage Time		1.5	4			
t_f Fall Time		1	3			
t_r Rise Time	$I_C = 0.75\text{ A}$, $I_B(1) = 75\text{ mA}$, $I_B(2) = -75\text{ mA}$, $V_{BE(off)} = -4.3\text{ V}$, $R_L = 267\ \Omega$, See Figure 1			0.15	0.5	μs
t_s Storage Time				2.5	6	
t_f Fall Time				0.5	3	

‡Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

*JEDEC registered data

PARAMETER MEASUREMENT INFORMATION



- NOTES:
- V_{gen} is a -30-V pulse (from 0 V) into a 50- Ω termination.
 - The V_{gen} waveform is supplied by a generator with following characteristics: $t_r \leq 15\text{ ns}$, $t_f \leq 15\text{ ns}$, $Z_{out} = 50\ \Omega$, $t_w = 20\ \mu\text{s}$, duty cycle $\leq 2\%$.
 - Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 15\text{ ns}$, $R_{in} \geq 10\text{ M}\Omega$, $C_{in} \leq 11.5\text{ pF}$.
 - Resistors must be noninductive types.
 - The d-c power supplies may require additional bypassing in order to minimize ringing.

FIGURE 1

TYPES 2N3583, 2N3584, 2N3585, 2N4240 N-P-N SILICON POWER TRANSISTORS

TYPICAL CHARACTERISTICS

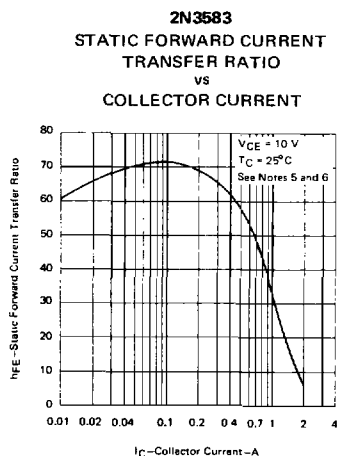


FIGURE 2

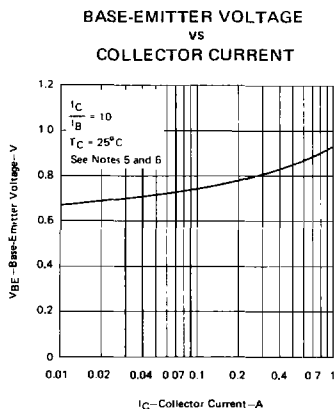


FIGURE 3

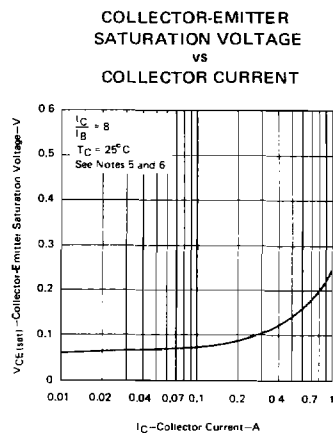


FIGURE 4

NOTES: 5. These parameters must be measured using pulse techniques. $t_W = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

6. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 0.125 inch from the device body.

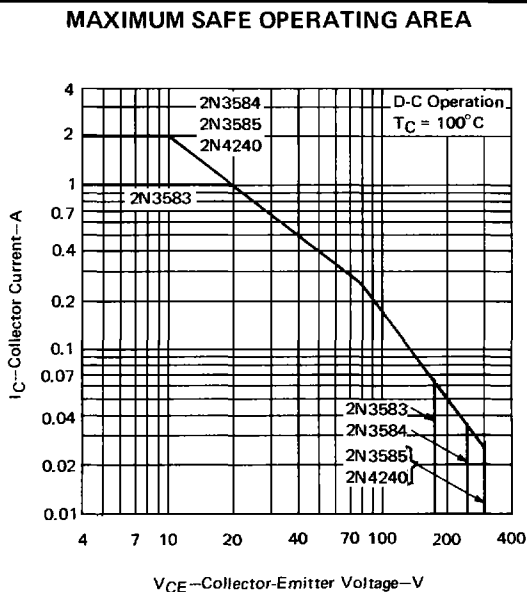


FIGURE 5

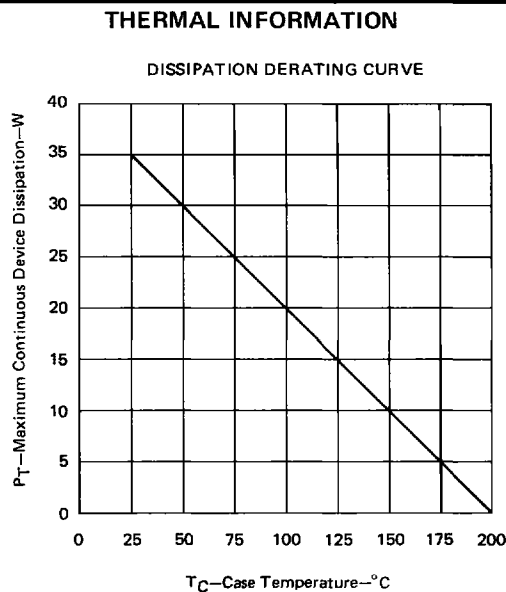


FIGURE 6